

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S1	1	plate and implantation and holes and trenches and pattern	EPO; JPO; DERWENT	OR	OFF	2005/10/24 10:06
S2	1	implantation and holes and trenches and pattern	EPO; JPO; DERWENT	OR	OFF	2005/10/20 17:18
S3	122	holes and trenches and pattern	EPO; JPO; DERWENT	OR	OFF	2005/10/20 17:19
S4	40	holes and trenches and pattern and mask	EPO; JPO; DERWENT	OR	OFF	2005/10/20 17:23
S5	865	(plate or die or (mask near cover)) same (metal near (lines or wires or contacts))	EPO; JPO; DERWENT	OR	OFF	2005/10/20 17:24
S8	67	(plate or die) same (metal near (lines or wires or contacts)) and pressure	EPO; JPO; DERWENT	OR	OFF	2005/10/20 17:25
S9	38	(plate or die) same (metal near (lines or wires)) and pressure	EPO; JPO; DERWENT	OR	OFF	2005/10/20 17:26
S10	58	(plate or die) same (metal near (lines or wires)) and pressure and damascene	US-PGPUB; USPAT; USOCR	OR	OFF	2005/10/20 17:32
S11	300	148/518.ccls.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/10/20 17:37
S12	210	118/721.ccls.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/10/20 17:37
S15	6	(metal near (wires or lines)) and 148/518.ccls.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/10/20 17:37
S16	1	("2169937").URPN.	USPAT	OR	OFF	2005/10/20 17:41
S17	48	stamp and (metal near (wires or lines))	USPAT	OR	OFF	2005/10/20 17:41
S18	9	("5641611" "5707745" "5900160" "5925259" "5998803" "6013538" "6027630" "6214631" "6294398").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/10/20 17:46

S20	94	("2905539" "3497377" "3641354" "3716359" "4011009" "4173075" "4274706" "4325779" "4330175" "4382657" "4477158" "4512848" "4528260" "4582566" "4587213" "4690715" "4728591" "4731155" "4802951" "4818336" "4842633" "4897325" "4999489" "5018829" "5020879" "5032216" "5079600" "5143854" "5202227" "5255273" "5259926" "5294369" "5315436" "5512131" "Re33581").PN. OR ("5900160").URPN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/10/20 17:48
S22	18	("2731333" "2977227" "3089800" "3139003" "3393453" "3720143" "4030967").PN. OR ("4173075").URPN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/10/20 17:50
S23	1	engrave\$3 near template and (metal near wires)	US-PGPUB; USPAT; USOCR	OR	OFF	2005/10/20 17:50
S36	459	(low near dielectric) and insulating and silicon and (metal near (wires or lines or interconnects)) and anneal\$3	US-PGPUB; USPAT; USOCR	OR	OFF	2005/10/27 17:11
S37	1	"5259926".pn.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/10/28 09:09
S38	49	("4294650" "4983499" "5008176" "5091047" "5093158" "5123998").PN. OR ("5259926").URPN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/10/28 09:09
S39	2947	427/331,355,356,369.ccls.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/10/28 09:19
S40	22	metal near(wires or lines or vias or interconnects) and 427/331,355,356,369.ccls.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/10/28 09:16
S41	9	dielectric and damascene and 427/331,355,356,369.ccls.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/10/28 09:18
S42	10	damascene and 427/331,355,356,369.ccls.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/10/28 09:18
S43	586	(lines or wires or vias or interconnects) and 427/331,355,356,369.ccls.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/10/28 09:20
S44	1092	(pattern or plate or die or stencil) and 427/331,355,356,369.ccls.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/10/28 09:20

S45	655	(pattern or plate or die or stencil or mask) and metal and 427/331,355,356,369.ccls.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/10/28 09:21
S46	475	(pattern or plate or die or stencil or mask) and metal and pressure and 427/331,355,356,369.ccls.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/10/28 09:21
S47	14	(pattern or plate or die or stencil or mask) and metal and pressure and trench and 427/331,355,356,369.ccls.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/10/28 09:24
S49	3982	427/256,271,272,282.ccls.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/10/28 09:24
S50	2047	metal and 427/256,271,272,282.ccls.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/10/28 09:24
S51	378	metal and dielectric and 427/256,271,272,282.ccls.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/10/28 09:25
S52	24	("4022927").URPN.	USPAT	OR	OFF	2005/10/28 09:51
S53	9	("4456675").URPN.	USPAT	OR	OFF	2005/10/28 09:53
S54	23	("20020042027" "20020127498" "4031268" "4407695" "4545610" "4801476" "5460922" "5772905" "5997958" "6309580" "6482742").PN. OR ("6713238").URPN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/10/28 09:53
S55	22	damascene and ((without or no) near photolithography)	US-PGPUB; USPAT; USOCR	OR	OFF	2005/10/28 09:41
S57	79	("3743842" "4310743" "4325779" "4383026" "4450358" "4498009" "4516253" "4552615" "4576678" "4606788" "4731155" "4832790" "5277749").PN. OR ("5772905").URPN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/10/28 09:55
S58	35	("3743842" "4310743" "4325779" "4383026" "4450358" "4498009" "4516253" "4552615" "4576678" "4606788" "4731155" "4832790" "5277749" "5861113").PN. OR ("6309580").URPN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/10/28 10:07
S59	30	("4325779" "4731155" "5234756" "5958326" "6159400" "6190929").PN. OR ("6482742").URPN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/10/28 10:08

S60	12	("5597613" "5658575" "5735985" "6110401" "6190929" "6225143" "6482742" "6518189" "6521324").PN. OR ("6716754").URPN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/10/28 10:10
S61	1	"6518189".pn.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/10/28 10:39
S62	20	("5595940" "5933411").PN. OR ("6518189").URPN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/10/28 10:59
S66	184	(contact near lithography) and dielectric and metal	US-PGPUB; USPAT; USOCR	OR	OFF	2005/10/28 11:01
S67	84	(imprint near lithography) and dielectric and metal and insulat\$3	US-PGPUB; USPAT; USOCR	OR	OFF	2005/10/28 11:07
S68	14545	(mold or die or plate) same pattern and layer	EPO; JPO; DERWENT	OR	OFF	2005/10/28 11:07
S69	329	(mold or die or plate) same pattern and dielectric and metal	EPO; JPO; DERWENT	OR	OFF	2005/10/28 11:08
S70	94	(mold or die or plate) same pattern and dielectric and metal and insulat\$3	EPO; JPO; DERWENT	OR	OFF	2005/10/28 11:50
S71	1128	silicon and (low near dielectric) and copper and difussion and electroless plating and anneal\$3 and damascene	US-PGPUB; USPAT; USOCR	OR	OFF	2005/10/28 14:06
S72	16	silicon and (low near dielectric) and copper and difussion and electroless plating and anneal\$3 and damascene	EPO; JPO; DERWENT	OR	OFF	2005/10/28 14:06
S73	1651	silicon and (low near dielectric) and copper and diffusion and electroless plating and anneal\$3 and damascene	US-PGPUB; USPAT; USOCR	OR	OFF	2005/10/28 14:13
S74	18	silicon and (low near dielectric) and copper and diffusion and electroless plating and anneal\$3 and damascene	EPO; JPO; DERWENT	OR	OFF	2005/10/28 14:06
S75	1211	silicon and (low near dielectric) and copper same diffusion same electroless plating and anneal\$3 and damascene	US-PGPUB; USPAT; USOCR	OR	OFF	2005/10/28 14:14
S76	17	silicon and (low near dielectric) and copper same diffusion same (electroless near plating) and anneal\$3 and damascene	US-PGPUB; USPAT; USOCR	OR	OFF	2005/10/28 14:14

S77	4910	438/945,613,612,622,690.ccls.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/10/31 08:54
S78	1347	dielectric and silicon and metal and copper and 438/945,613,612,622, 690.ccls.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/10/31 08:55
S79	388	dielectric same insulating and silicon and metal and copper and via and 438/945,613,612,622,690.ccls.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/10/31 09:14
S80	68	("5091339").URPN.	USPAT	OR	OFF	2005/10/31 09:09
S81	560	438/690.ccls.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/10/31 09:14
S82	0	lown near dielectric and 438/690. ccls.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/10/31 09:14
S83	51	low near dielectric and 438/690.ccls.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/10/31 09:14
S84	3519	438/637-640.ccls.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/10/31 14:11
S85	785	low near dielectric and silicon and metal and 438/637-640.ccls.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/10/31 14:40
S87	669	low near dielectric and silicon and metal and copper and 438/637-640. ccls.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/10/31 14:12
S88	386	low near dielectric and silicon and metal and copper and diffusion and 438/637-640.ccls.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/10/31 14:12
S89	374	438/975.ccls.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/10/31 14:47
S90	1	"6716754".pn.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/10/31 14:47
S91	12	("5597613" "5658575" "5735985" "6110401" "6190929" "6225143" "6482742" "6518189" "6521324").PN. OR ("6716754"). URPN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/10/31 14:47
S92	20	("5595940" "5933411").PN. OR ("6518189").URPN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/10/31 14:51
S93	297	438/945.ccls.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/10/31 14:55

S94	174	438/951.ccls.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/10/31 14:59
S95	154	dielectric and insulating and (plate or mold or mask or die or stamp) and metal and (via or vias)	EPO; JPO; DERWENT	OR	OFF	2005/10/31 15:08
S97	34	148/95.ccls.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/10/31 15:10
S10 0	2630	pattern near3 (substrate) near10 (plate or die or mold)	US-PGPUB; USPAT; USOCR	OR	OFF	2005/10/31 15:11
S10 2	177	pattern near3 (substrate) near10 (plate or die or mold) and dielectric and silicon and metal same (contacts or vias or interconnects or lines or wires)	US-PGPUB; USPAT; USOCR	OR	OFF	2005/10/31 15:26
S10 3	18	damascene near3 (mold or molds)	US-PGPUB; USPAT; USOCR	OR	OFF	2005/10/31 15:35
S10 4	1	"6696224".pn.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/10/31 15:35
S10 5	1	"6334960".pn.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/10/31 15:36